

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

Smith, Lee John; Zoba, David Albert

Assignee:

Amkor Technology, Inc.

Title:

Thin Semiconductor Package Including Stacked Dies

Serial No.:

09/944,732

Filing Date:

August 31, 2001

Examiner:

Unknown

Group Art Unit:

Unknown

Docket No.:

M-11443 US

San Francisco, California October 5, 2001

COMMISSIONER FOR PATENTS Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR § 1.97(b)

Dear Sir:

Pursuant to 37 C.F.R. § 1.56, § 1.97 and § 1.98, the documents listed on the accompanying form PTO-1449 are called to the attention of the Examiner for the above patent application. Copies of these documents are enclosed.

Citation of these documents shall not be construed as:

- 1. an admission that the documents are necessarily prior art with respect to the instant invention;
 - 2. a representation that a search has been made; or
- 3. an admission that the information cited herein is, or is considered to be, material to patentability as defined in § 1.56(b).

EXPRESS MAIL LABEL NO:

EL 873 075 341 US

Respectfully submitted,

Robert D. Wasson

Attorney for Applicant(s)

Reg. No. 40,218

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U.S. Departm	ent of Co	mmerce, Patent and	Atty Docket No. Serial No.							
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TRADEMI	it.		U.S.	Patent Documents						
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	AA	6,005,778	12/21/99	Spielberger, et al.	361	770	пиррю	priate		
	AB	5,229,647	7/20/93	Gnadinger	257	785				
	AC	3,851,221	11/26/74	Beaulieu, et al.	317	100				
	AD	4,730,232	3/8/88	Lindberg	361	381				
	AE	4,763,188	8/9/88	Johnson	357	74				
	AF	4,982,265	1/1/91	Watanabe, et al.	357	75				
	AG	5,025,306	6/18/91	Johnson, et al.	357	75				
	AH	5,040,052	8/13/91	McDavid	357	80		 		
	AI	5,140,404	8/18/92	Fogal, et al.	357	70				
	AJ	5,291,061	3/1/94	Ball	257	686				
	AK	5,323,060	6/21/94	Fogal, et al	257	777				
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	AL	62-12661 Eng. Abs.	6/8/87	Japan	H01L	25/04				
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	BB	5,682,062	10/28/97	Gaul	257	686	 		
	BC	5,721,452	2/24/98	Fogal, et al.	257	685	 		
	BD	5,739,581	4/14/98	Chillara, et al.	257	668		.	
	BE	5,815,372	9/29/98	Gallas	361	760	700		
	BF	5,872,025	2/16/99	Cronin, et al.	438	109		1	
	BG	5,886,412	3/23/99	Fogal, et al.	257	777	29		
	BH	Re. 36,613	3/14/00	Ball	257				
-	BI	6,051,886	4/18/00			777	70001A		
	BJ	 	 	Fogal, et al.	257	777			
		6,057,598	5/2/00	Payne, et al.	257	723			
	BK	5,861,666	1/19/99	Bellaar	257	686	<u> </u>		
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		Document 61117858 Fng	Date	Country	Class	Subclass	Yes	No	
****	BL	61117858 Eng. Abs.	6/5/86	Japan	HO1L	25/08			
	BM	4028260 Eng. Abs.	1/30/92	Japan	H01L	25/065			
	BN	4116859 Eng. Abs.	4/17/92	Japan	H01L	25/065			
	ВО	4096358 Eng.	3/27/92	Japan	H01L	25/065			
	BP	Abs. 5013665 Eng.	1/22/93	Japan	H01L	25/065			
		Abs. OTHER	ART (Including)	Author, Title, Date, Per	tinent Pages Et	c)	1.	<u> </u>	
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INFO	DRMATIC	N DISCLOSURE	STATEMENT B	Y APPLICANT	Applicants					
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Examiner Examiner		Document			- CI	0.1.1	Filing 1			
Initial	CA	Number 5,165,067	Date 11/17/92	Name Wakefield, et al.	Class 257	Subclass 783	If Appro	priate		
	CB	5,614,766	3/25/97	Takasu, et al.	257	777	 			
	CC	5,587,341	12/24/96							
		ļ		Masayuki, et al.	437	206				
	CD	5,473,196	12/5/95	De Givry	257	786		<u>.</u>		
	CE	5,426,563	6/20/95	Moresco, et al.	361	689	7			
	CF	5,502,289	3/26/96	Takiar, et al.	174	266	700			
-	CG	5,422,435	6/6/95	Takiar, et al.	174	52.4	C. 60			
	СН	5,334,875	8/2/94	Sugano, et al.	257	686	32			
	CI	5,198,888	3/30/93	Sugano, et al.	257	686	7	· ·		
	CJ	5,793,108	8/11/98	Nakahishi, et al.	257	723	00			
	CK	5,783,870	7/21/98	Mostafazadeh, et al.	257	791	- American			
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	CL	4-368154 A	12/21/92	Japan	HOIL	23/00		X		
	CM	54-128274	4/10/79	Japan	HOIL	23/30		$\frac{1}{X}$		
	CN	w/Eng. Abs. 1028856	1/31/89	Japan	H01L	27/00		$\frac{1}{X}$		
		w/Eng. Abs. 1099248 A				· · ·	77			
	СО	w/Eng. Abs. 60182731	4/18/89	Japan	H01L	25/08	X	_		
	CP	w/Eng. Abs.	9/18/85	Japan	H01L	21/60		X		
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Initial	DA	Number 5,973,403	Date 10/26/99	Name Wark	Class 257	Subclass 777	If Appro	priate	
	DB	5,917,242	6/29/99	Ball	257	737			
	DC	5,696,031	12/9/97	Wark	437	209	<u></u>		
	DD	5,637,912	6/10/97	Cockerill, et al.	257	620		- 1	
	DE	5,637,536	6/10/97	Val	438	686		<u> </u>	
	DF	5,581,498	12/3/96	Ludwig, et al.	365	63	29		
	DG	5,514,907	5/7/96	Moshayedi	257	723		1	
	DH	5,495,398	2/27/96	Takiar, et al.	361	790	1		
	DI	5,495,394	2/27/96	Kornfeld, et al.	361	764	ROOM		
	DJ	5,463,253	10/31/95	Waki, et al.	257	724			
	DK	5,012,323	4/30/91	Farnworth	357	75			
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	DL	56062351 w/Eng. Abs.	5/28/81	Japan	HOIL	25/04		X	
	DM	3169062 w/Eng.	7/23/91	Japan	HOIL	25/065		X	
	DN	Abs. 10-256470	9/25/98	Japan	HOIL	25/065	X	<u> </u>	
 	DO	1071162 A Eng.	3/16/89	Japan	HOIL	23/52		+	
	DP	Abs 5-75015 (A) Eng.	3/26/93	Japan	HOIL	25/065		$\frac{1}{X}$	
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7	1				Filing Date	;	Group			
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Initial	EA	Number 4,996,587	Date 2/26/91	Name Hinrichsmeyer, et al.	Class 357	74	If Appro	priate		
	EB	4,567,643	2/4/86	Droguet, et al.	29	575				
	EC	5,793,108	8/11/98	Nakanishi, et al.	257	723				
	ED	5,689,135	11/18/97	Ball	257	676				
	EE	5,138,438	8/11/92	Masayuki, et al.	357	75	 			
	EF	5,347,429	9/13/94	Kohno, et al.	361	813		٧,		
	EG	6,080,264	6/27/00	Ball	156	292		1) 2)		
	ЕН	5,422,435	6/6/95	Takiar, et al.	174	52.4	20			
	EI	5,569,625	10/29/96	Yoneda, ct al.	29	827	7	. \		
	EJ	5,798,014	8/25/98	Weber	156	263	7			
	EK	5,885,849	3/23/99	DiStefano, et al.	438	108	7000			
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	EL	4-368167 w/Eng. Abs.	12/21/92	Japan	H01L	25/065		X		
	EM	5-283601	10/29/93	Japan	H01L	23/52		X		
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	EO	64001269 Eng. Abs.	1/5/89	Japan	HOIL	25/04				
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Initial	FA	Number 5,952,611	Date 9/14/99	Name Eng, et al.	Class 174	Subclass 52.4	If Appro	priate		
	FB	6,072,243	6/6/00	Nakanishi	257	783				
	FC	6,184,463	2/6/01	Panchou, et al.	174	52.4		-		
<u></u>	FD	6,235,554	5/22/01	Akram, et al.	438	109				
	FE	6,214,641	4/10/01	Akram	438	107		, <u></u>		
	FF	5,715,147	2/3/98		361			!		
	FG	6,133,637	10/17/00	Nagano Hikita et al	257	813 C		-		
	FH	6,034,427		Hikita, et al.			N			
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	FJ	6,013,948	1/11/00	Akram et al.	257	698				
•	FK	6,160,705	12/12/00	Stearns et al.	361	704				
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	FL	61059862 Eng. Abs	3/27/86	Japan	H01L	25/04				
	FM	62119952 Eng. Abs.	6/1/87	Japan	H01L	25/04				
	FN	62126661 Eng. Abs.	6/8/87	Japan	H01L	25/04				
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	GF						700		
	GG						25 0 m		
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	GI	Abs. 62126661 w/Eng.	6/8/87	Japan	H01L	25/04		X	
	GJ	Abs. 63128736 w/Eng. Abs.	6/1/88	Japan	HOIL	23/04		X	
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	GN	1019990037925	9/7/99 (App. Date)	Korea				X	
	GO	1019990037928	9/7/99 (App. Date)	Korea				X	
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